



深圳市思迪科科技有限公司

SHENZHEN CDTECH ELECTRONICS

Product Specification

Model Name	S070BWS115FD-DC103
Description	7.0" WSVGA 1024(RGB)x600 Dots
Date	2022/03/01
Version	1.0

Approved by/Date	Check by/Date	Prepared by/Date
ZHP 2022/03/01	HL 2022/03/01	ZWF 2022/03/01

Customer Approval	
Date	



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Table of Contents

1. Record of Revision	3
2. General Specifications	4
3. Input/Output Terminals	5
4. Absolute Maximum Rating	7
5. Electrical Characteristics	7
6. Interface Timing	9
7. Optical Characteristics	14
8. Environmental / Reliability Tests	17
9. Mechanical Drawing	19
10. Packing	20
12. Precautions for Use of LCD modules	21



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1. Record of Revision

Rev	Issued Date	Description	Editor
1.0	2022/03/01	First Release.	ZWF

2. General Specifications

	Feature	Spec
Characteristics	Size	7 inch
	Resolution	1024(horizontal)*600(Vertical)
	Interface	LVDS
	Connect type	Connector
	Display Colors	16.7M
	Technology type	a-Si
	Pixel pitch (mm)	0.150*0.143
	Pixel Configuration	R.G.B.-Stripe
	Display Mode	Normally Black
	LCD Driver IC	EK79001HN+EK73215BCGA
	CTP Driver IC	ILI2511
	Viewing Direction	Full view
Mechanical	LCM (W x H x D) (mm)	165.00*100.00*7.87
	Active Area(mm)	154.21 x85.92
	With /Without TSP	With CTP
	Weight (g)	TBD
	LED Numbers	30 LEDs

Note 1: Requirements on Environmental Protection: RoHs

Note 2: LCM weight tolerance: +/- 5%

3. Input/Output Terminals

LCD PIN-MAP

No.	Symbol	Description
1	VCOM	Common Voltage
2	VDD	Power Voltage for digital circuit
3	VDD	Power Voltage for digital circuit
4	NC	No connection
5	RESET	Global reset pin
6	STBYB	Standby mode Normally pulled high STBYB=1,normal operation STBYB=0,timing contrller,source Driver will turn off,all output are High-Z
7	GND	Ground
8	RXIN0-	-LVDS differential data input
9	RXIN0+	+LVDS differential data input
10	GND	Ground
11	RXIN1-	-LVDS differential data input
12	RXIN1+	+LVDS differential data input
13	GND	Ground
14	RXIN2-	-LVDS differential data input
15	RXIN2+	+LVDS differential data input
16	GND	Ground
17	RXCLKIN-	-LVDS differential clock input
18	RXCLKIN+	+LVDS differential clock input
19	GND	Ground
20	RXIN3-	-LVDS differential data input
21	RXIN3+	+LVDS differential data input
22	GND	Ground
23	NC	No connection
24	NC	No connection
25	GND	Ground
26	NC	No connection
27	DIMO	Backlight CABC controller signal output
28	SELB	6bit/8bit mode select (Note 1)
29	AVDD	Power for Analog Circuit
30	GND	Ground
31	LED-	LED Cathode

32	LED-	LED Cathode
33	L/R	Horizontal inversion (Note 2)
34	U/D	Vertical inversion (Note 2)
35	VGL	Gate oFF Voltage Power supply
36	NC	No connection
37	NC	No connection
38	VGH	Gate ON Voltage
39	LED+	LED Anode
40	LED+	LED Anode

Note 1: if LVDS input data is 6bit,selb must be set to high;

if LVDS input data is 8bit,selb must be set to low;

Note 2: when L/R=0 set right to left scan direction

when L/R=1 set left to right scan direction

when U/D=0 set top to bottom scan direction

when U/D=1 set bottom to top scan direction

CTP PIN-MAP

Pin	Signal	Description
1	GND	Ground
2	SDA	I2C data input and output
3	SCL	I2C clock input
4	VDD	Power supply
5	INT	Interrupt request to the host
6	RESET	Reset Pin for CTP

4. Absolute Maximum Rating

Item	Symbol	MIN	Typ	MAX	Unit	Remark
Supply Voltage	VDD	-0.3	-	5	V	-
Operating Temperature	TOPR	-20	-	70	°C	-
Storage Temperature	TSTG	-30	-	80	°C	-

5. Electrical Characteristics

5.1 Driving TFT LCD Panel

Item	Symbol	MIN	TYP	MAX	Unit	Remark
Power supply for LCD	VDD	3.0	3.3	3.6	V	
	AVDD	9.0	9.8	10.5	V	
	VGH	16.0	18.0	20	V	
	VGL	-7.5	-6.0	-5.0	V	
	VCOM	2.9	3.25	3.5	V	

5.2 CTP Electrical Characteristics

FPC Design	Item	Description	Remark
COF	IC solution on TP Model	ILI2511	
	Touch Count Max	5 point	
	Display Resolution	1024*600	
	Interface Type	I2C	
	I2C Slave Address	0X82	
	Origin of Coordinate	Top left corner	

Parameter	Min	Typ	Max	Unit
Interface Signal Voltage	-	2.8	-	V
Power Voltage	VDD	3.3	-	V

5.3 LED Driving Conditions

Item	Symbol	MIN	TYP	MAX	Unit	Remark
Forward Current	I_F	-	400	-	mA	
Forward Voltage	V_F	8.1	-	10.2	V	
Backlight Power consumption	W_{BL}	3.24	-	4.08	W	
LED Lifetime		-	50000	-	Hrs	

Note 1: Each LED: $I_F = 20 \text{ mA}$, $V_F = 2.7\text{-}3.4\text{V}$.

Note 2: Optical performance should be evaluated at $T_a = 25^\circ\text{C}$ only.

Note 3: If LED is driven by high current, high ambient temperature & humidity condition. The life Time of LED will be reduced. Operating life means brightness goes down to 50% initial brightness. Typical operating life time is estimated data.

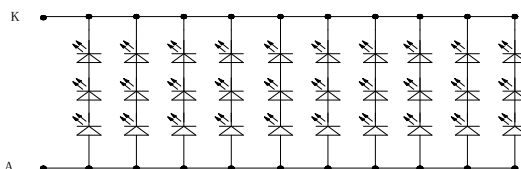
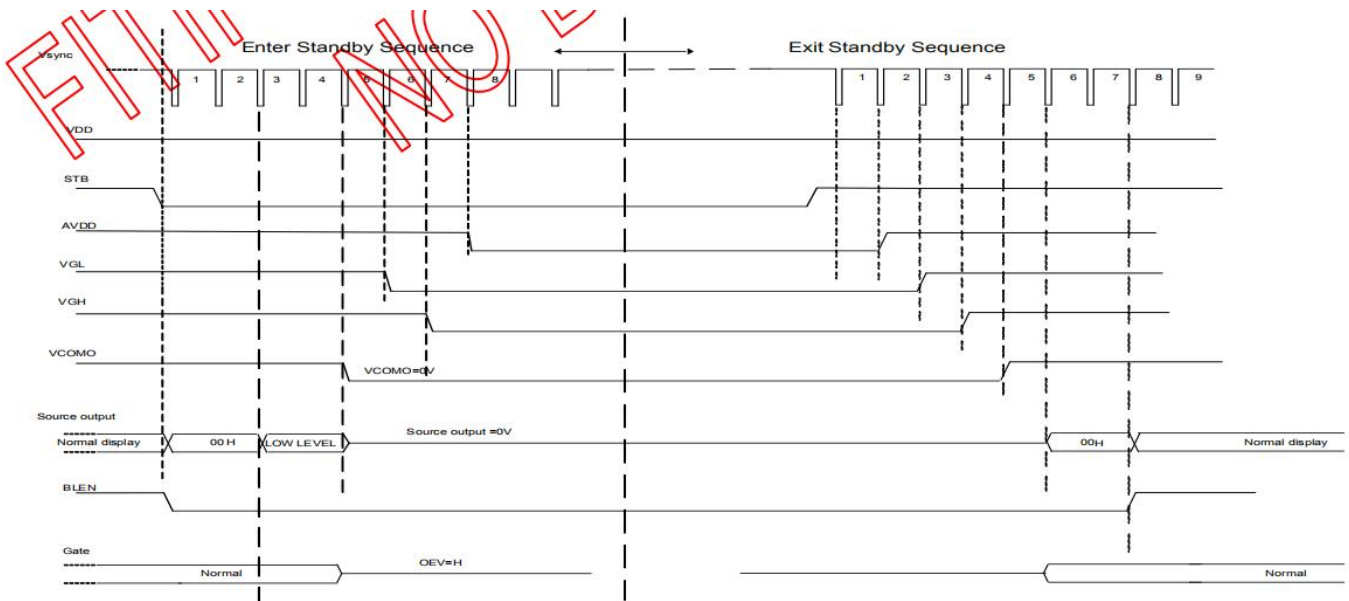
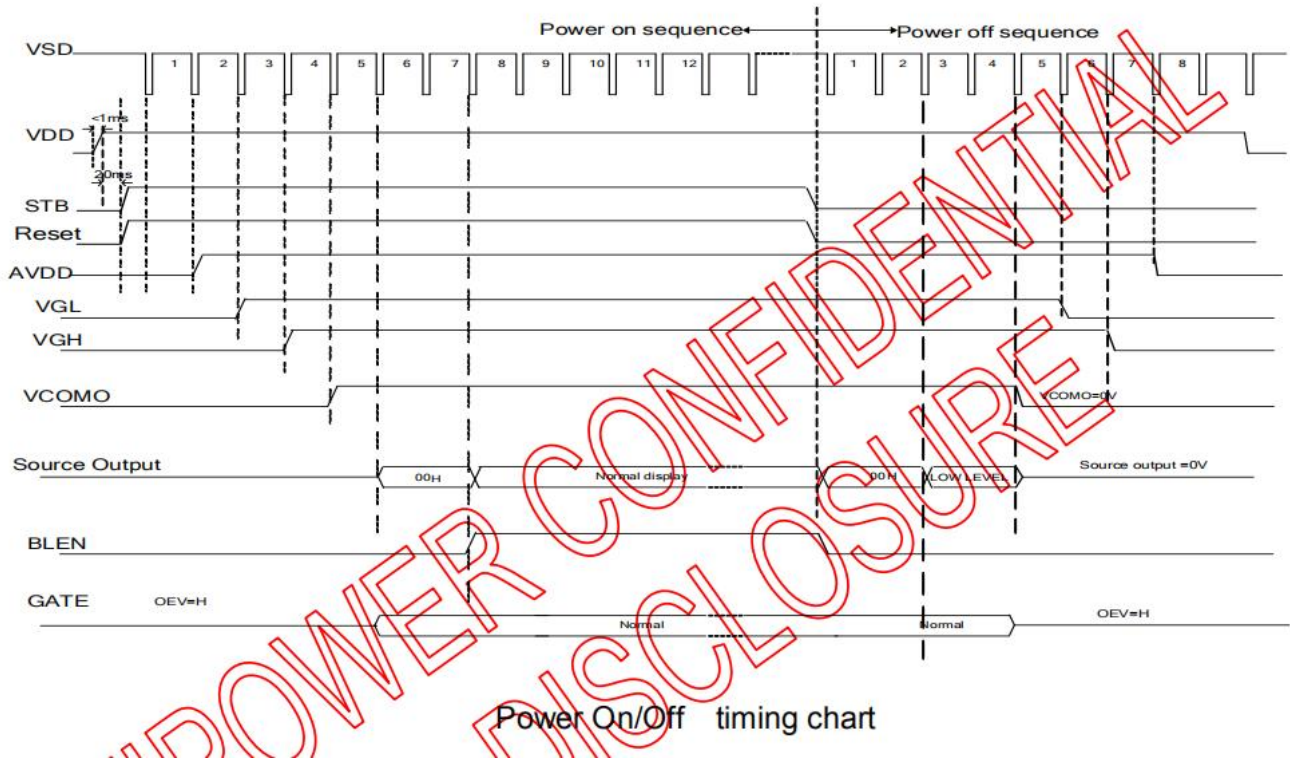


Figure: LED connection of backlight(Constant Current)

6. Interface Timing

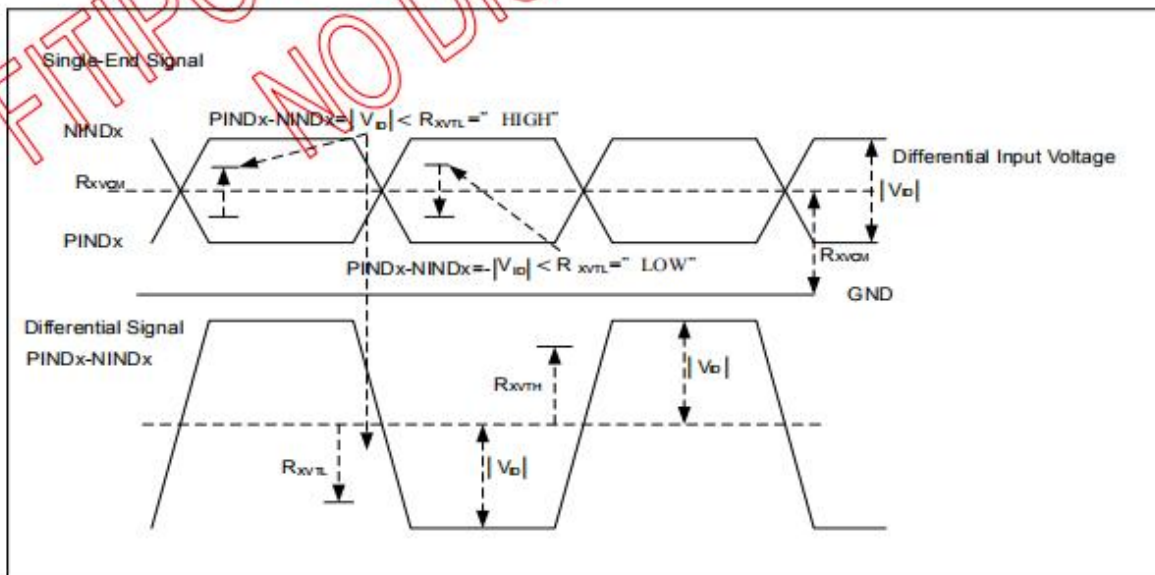
6.1 Power sequence



6.2 Timing Characteristics

LVDS DC characteristic

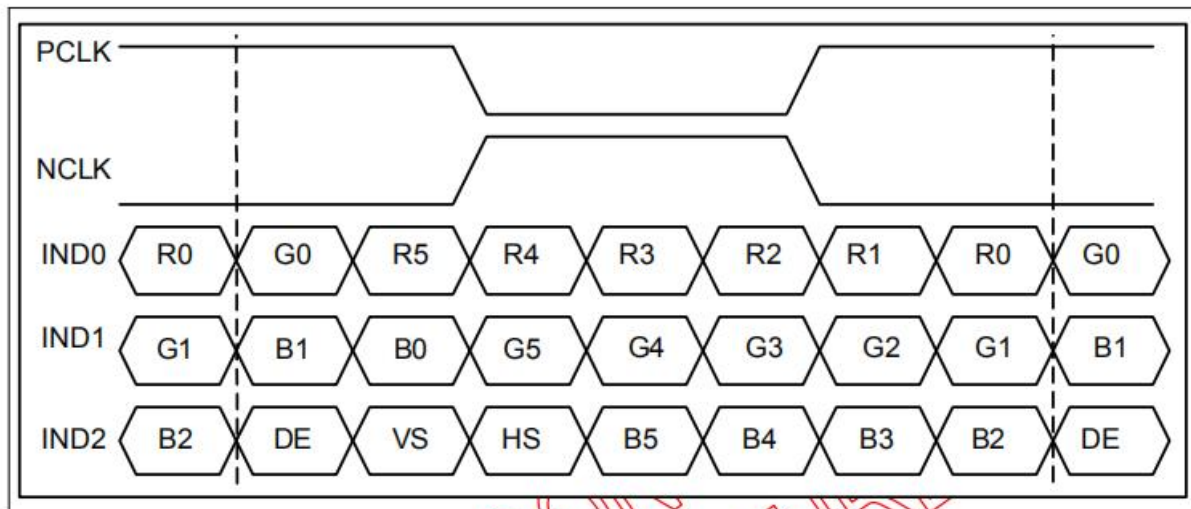
Parameter	Symbol	Min.	Typ.	Max.	Unit	Condition
Differential input high threshold voltage	R_{xVTH}			+0.1V	V	$R_{xVCM}=1.2V$
Differential input low threshold voltage	R_{xVTL}	-0.1			V	
Input voltage range(single-end)	R_{xVIN}	0		2.4	V	
Differential input common mode voltage	R_{xVCM}	$ V_{ID} /2$		$2.4 - V_{ID} /2$	V	
Differential input voltage	$ V_{ID} $	0.2		0.6	V	
Differential input leakage current	R_{xVTH}	-10		+10	μA	
LVDS Digital Operating Current	I_{ddlvds}	-	40(TBD)	50	mA	Fclk=65Mhz, VDD=3.3V
LVDS Digital Standby Current	I_{stlvds}	-	10(TBD)	50	μA	Clock & all functions are stop



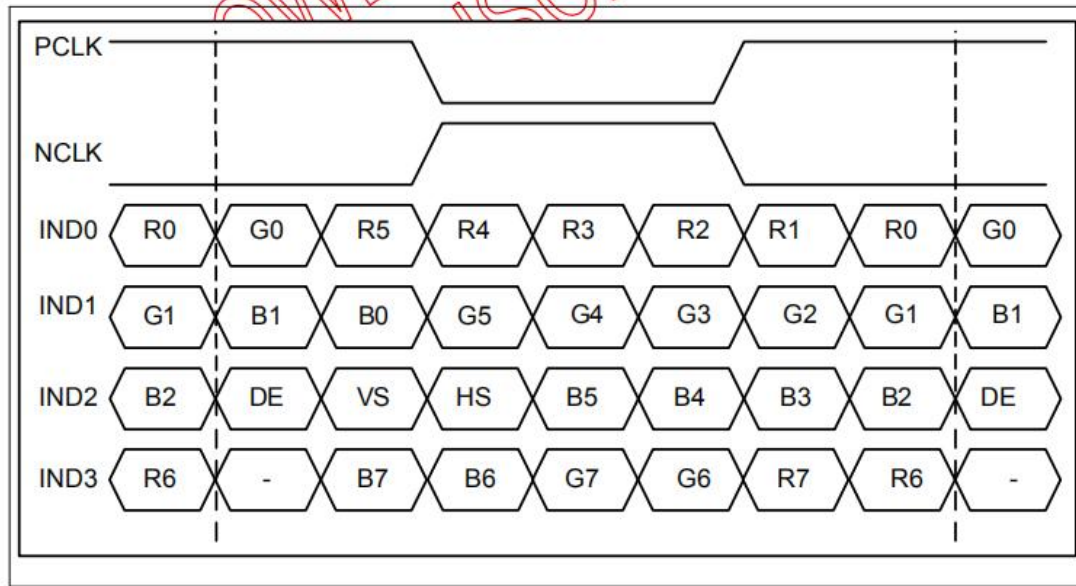
LVDS DC Characteristic

LVDS mode

Parameter	Symbol	Condition	Min.	Typ.	Max.	Unit
Clock Frequency	RxFCLK		20	-	71	MHz
Input data skew margin	TRSKM	$ V_{ID} =400\text{mV}$ $R_{xVCM}=1.2\text{V}$ $R_{x}FCLK=71\text{MHz}$	500			ps
Clock High Time	TLVCH			$4/(7 \cdot R_{x}FCLK)$		ns
Clock Low Time	TLVCL			$3/(7 \cdot R_{x}FCLK)$		ns
PLL wake-up-time	TenPLL				150	us



6-bit LVDS Input Timing chart



8-bit LVDS Input Timing chart

6.3 Capacitive touch panel Specification

I2C

The I2C is always configured in the Slave mode. The data transfer format is shown in [Figure 2-4](#).

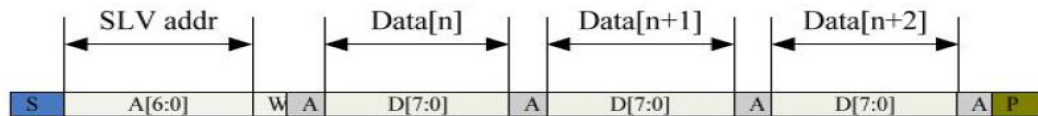
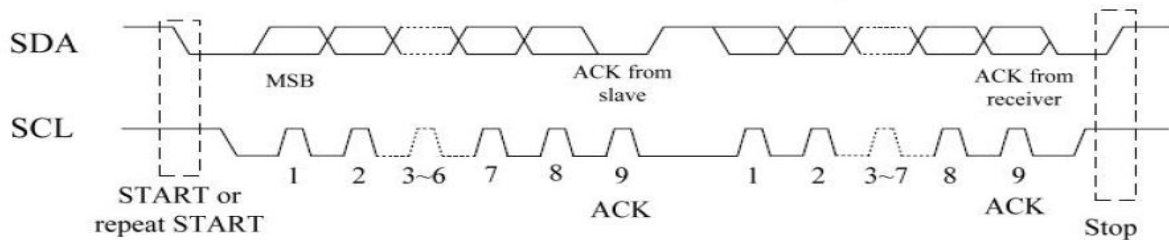


Figure 2-5 I2C master write, slave read

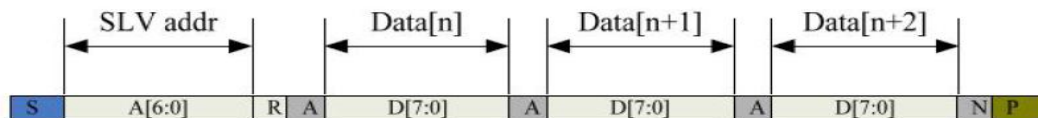


Figure 2-6 I2C master read, slave write

Table 2-1 lists the meanings of the mnemonics used in the above figures.

Table 2-1 Mnemonics Description

Mnemonics	Description
S	I2C Start or I2C Restart
A[6:0]	Slave address A[6:4]: 3'b011 A[3:0]: data bits are identical to those of I2CCON[7:4] register.
W	1'b0: Write
R	1'b1: Read
A(N)	ACK(NACK)
P	STOP: the indication of the end of a packet (if this bit is missing, S will indicate the end of the current packet and the beginning of the next packet)

I2C Interface Timing Characteristics is shown in Table 2-2.

Table 2-2 I2C Timing Characteristics

Parameter	Unit	Min	Max
SCL frequency	KHz	0	400
Bus free time between a STOP and START condition	us	4.7	\
Hold time (repeated) START condition	us	4.0	\
Data setup time	ns	250	\
Setup time for a repeated START condition	us	4.7	\
Setup Time for STOP condition	us	4.0	\

7. Optical Characteristics

Items		Symbol	Condition	Min.	Typ.	Max.	Unit	Remark	Note
Response time		Tr+Tf	-	-	30	40	ms	FIG.1	Note4
Contrast Ratio		CR		500	800	-	-	FIG.2	Note1
Surface luminance		LV	$\theta=0^{\circ}$	1000	1200	-	cd/m2	FIG.2	Note2
Luminance uniformity		Yu	$\theta=0^{\circ}$	70	75	-	%	FIG.2	Note3
NTSC		-	$\theta=0^{\circ}$	-	50	-	%	FIG.2	Note5
Viewing angle		θ_T	Center CR ≥ 10	-	85	-	deg	FIG.3	Note6
		θ_B		-	85	-	deg	FIG.3	
		θ_L		-	85	-	deg	FIG.3	
		θ_R		-	85	-	deg	FIG.3	
Chromaticity	Red	R_X	$\theta=0^{\circ}$ $\varnothing=0^{\circ}$ $T_a=25^{\circ}$	0.549	0.599	0.649	-	FIG.2 CIE1931	Note5
		R_Y		0.255	0.338	0.355	-		
	Green	G_X		0.249	0.299	0.349	-		
		G_Y		0.500	0.550	0.600	-		
	Blue	B_X		0.089	0.139	0.189	-		
		B_Y		0.081	0.131	0.181	-		
	White	W_X		0.258	0.308	0.358	-		
		W_Y		0.286	0.336	0.386	-		

Note1. Definition of contrast ratio

Contrast ratio(Cr) is defined mathematically by the following formula. For more information see FIG.2.

$$\text{Contrast ratio} = \frac{\text{Luminance measured when LCD on the "White" state}}{\text{Luminance measured when LCD on the "Black" state}}$$

For contrast ratio, Surface Luminance, Luminance uniformity and CIE,the testing data is base on TOPCON's BM-5 or BM-7 photo detector or compatible.

Note2. Definition of surface luminance.

Surface luminance is the luminance with all pixels displaying white. For more information see FIG.2.

L_v = Average Surface Luminance with all white pixels($P_1, P_2, P_3, \dots, P_n$)

Note3. Definition of luminance uniformity

The luminance uniformity in surface luminance is determined by measuring luminance at each test position 1 through n, and then dividing the maximum luminance of n points luminance by minimum luminance of n points luminance.For more information see FIG.2.

$$YU = \frac{\text{Minimum surface luminance with all white pixels } (P_1, P_2, P_3, \dots, P_n)}{\text{Maximum surface luminance with all white pixels } (P_1, P_2, P_3, \dots, P_n)}$$

Note4. Definition of response time

The response time is defined as the LCD optical switching time interval between “White” state and “Black” state. Rise time (T_r) is the time between photo detector output intensity changed from 90% to 10%. And fall time (T_f) is the time between photo detector output intensity changed from 10% to 90%.

For additional information see FIG1.

Note5. Definition of color chromaticity (CIE1931)

CIE (x,y) chromaticity, The x,y value is determined by screen active area center position P5. For more information see FIG.2.

Note6. Definition of viewing angle

Viewing angle is the angle at which the contrast ratio is greater than 10. Angles are determined for the horizontal or x axis and the vertical or y axis with respect to the z axis which is normal to the LCD surface. For more information see FIG.3.

For viewing angle and response time testing, the testing data is base on Autronic-Melchers's ConoScope or DMS series Instruments or compatible.

FIG.1. The definition of response Time

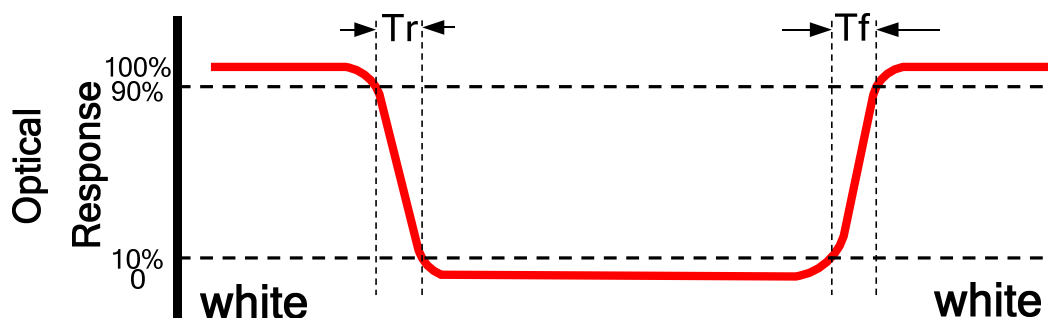


FIG.2. Measuring method for contrast ratio, surface luminance,

luminance uniformity, CIE (x,y) chromaticity

Size : $S \leq 5"$ (see Figure a) A : 5 mm B : 5 mm

H,V : Active area

Light spot size $\varnothing = 5\text{mm}$ (BM-5) or $\varnothing = 7.7\text{mm}$ (BM-7) 50cm distance or compatible distance from the LCD surface to detector lens.

test spot position : see Figure a.

measurement instrument : TOPCON's luminance meter BM-5 or BM-7 or compatible (see Figure c).

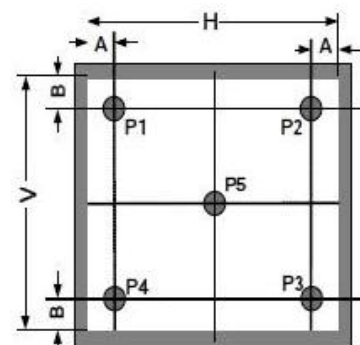


Figure a

Size : $5" < S \leq 12.3"$ (see Figure b) H,V : Active area

Light spot size $\varnothing = 5\text{mm}$ (BM-5) or $\varnothing = 7.7\text{mm}$ (BM-7) 50cm distance or compatible distance from the LCD surface to detector lens.

test spot position : see Figure b.

measurement instrument : TOPCON's luminance meter BM-5 or BM-7 or compatible (see Figure c).

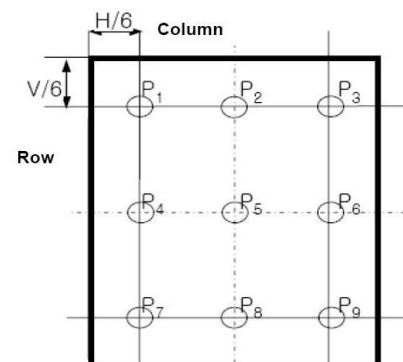


PHOTO DETECTOR

BM-5/BM-7

FIELD=1°

50 cm

LCD PANEL

TFT-LCD MODULE

CENTER OF THE SCREEN

Figure c

8. Environmental / Reliability Tests

No	Test Item	Condition	Remarks
1	High Temperature Operation	Ts= +70℃, 96hrs	IEC60068-2-1:2007 GB2423. 2-2008
2	Low Temperature Operation	Ta= -20℃, 96hrs	IEC60068-2-1:2007 GB2423.1-2008
3	High Temperature Storage	Ta= +80℃, 96hrs	IEC60068-2-1:2007 GB2423. 2-2008
4	Low Temperature Storage	Ta= -30℃, 96hrs	IEC60068-2-1:2007 GB2423.1-2008
5	High Temperature & Humidity Operation	Ta= +60℃, 90% RH max, 96 hours	IEC60068-2-78:2001 GB/T2423.3-2006
6	Thermal Shock (Non-operation)	-30℃ 30 min ~ +80℃ 30 min Change time: 5min, 20 Cycle	Start with cold temperature, end with high temperature IEC60068-2-14:1984, GB2423.22-2002
7	ESD	C=150pF, R=330 Ω, 5 points/panel , Air:±8KV, 5 times Contact: ±4KV, 5 times (Environment: 15℃ ~ 35℃, 30% ~ 60%, 86Kpa ~ 106Kpa)	IEC61000-4-2:2001 GB/T17626.2-2006
8	Vibration (Non-operation)	Frequency range: 10~55Hz, Stroke: 1.5mm , Sweep: 10Hz~55Hz~10Hz 2 hours for each direction of X .Y. Z. (6 hours for total)	IEC60068-2-6:1982 GB/T2423.10-1995
9	Mechanical Shock (Non-operation)	Half Sine Wave 60G ,6ms,±X,±Y,±Z 3times for each direction	IEC60068-2-27:1987 GB/T2423.5—1995
10	Package Drop Test	Height: 60 cm, 1 corner, 3 edges, 6 surfaces	IEC60068-2-32:1990 GB/T2423.8-1995



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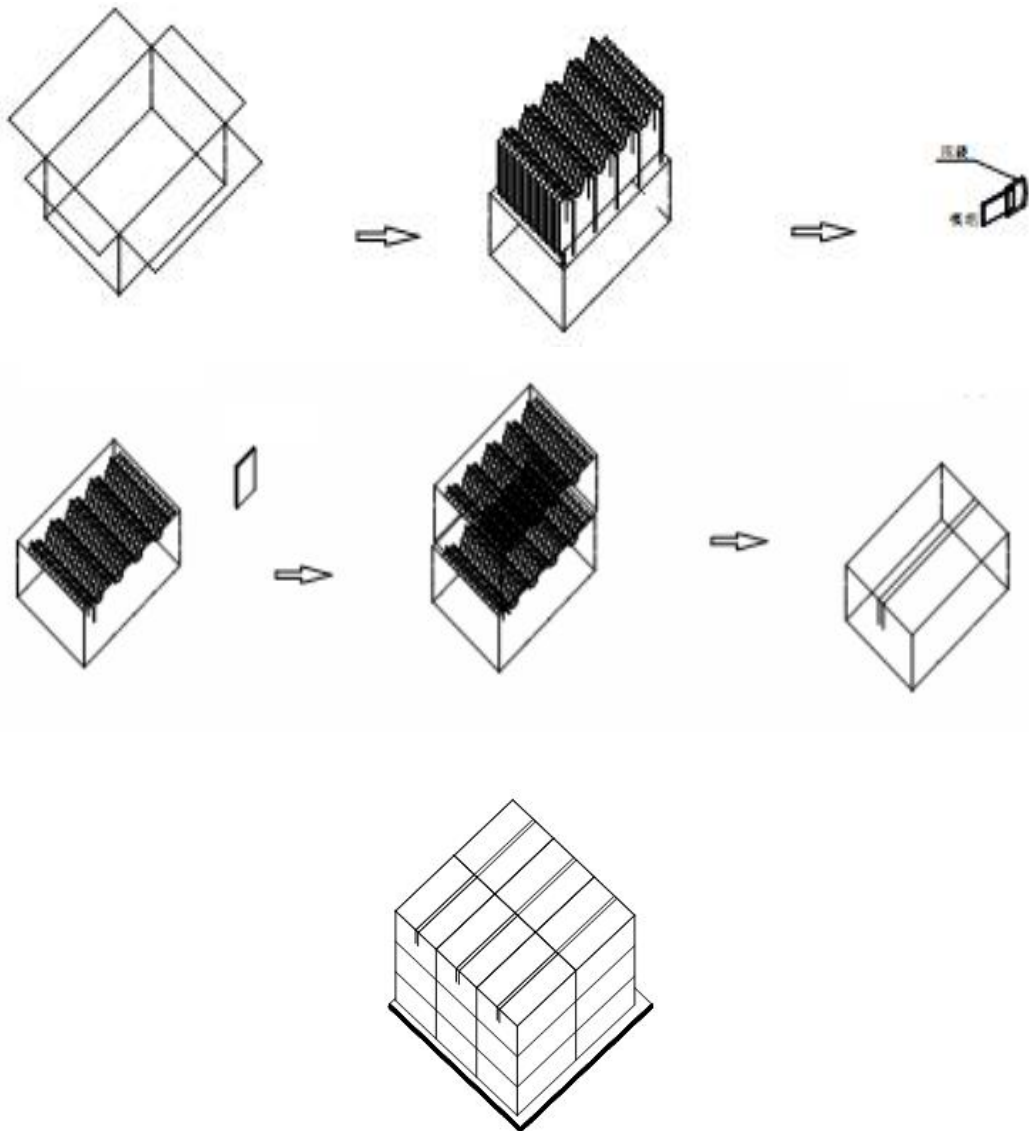
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Notes:

1. The test result shall be evaluated after the sample has been left at room temperature and humidity for 2 hours without load. No condensation shall be accepted. The sample will not be accepted if appear these defects:
 - 1).Air bubble in the LCD;
 - 2).Seal leak
 - 3).Non-display
 - 4).missing segments
 - 5).Glass crack
 - 6).CR reduction >40%
 - 7).IDD increase >100%
 - 8).Brightness reduction >50%
 - 9).Color coordinate tolerance >0.05
- 2.≤7.0 inch: The size of sample is 5pcs;
>7.0 inch: The size of sample is 2pcs;
3. One test sample must complete each test item;
- 4.In case of malfunction defect caused by ESD damage, if it would be recovered to normal state after resetting, it would be judge as a good part.
- 5.In the test of High Temperature Operation and High Temperature & Humidity Operation ,the operation temperature is the surface temperature of module.

10. Packing

Packing Method



11. Precautions for Use of LCD modules

11.1 Handling Precautions

11.1.1. The display panel is made of glass. Do not subject it to a mechanical shock by dropping it from a high place, etc.

11.1.2. If the display panel is damaged and the liquid crystal substance inside it leaks out, be sure not to get any in your mouth, if the substance comes into contact with your skin or clothes, promptly wash it off using soap and water.

11.1.3. Do not apply excessive force to the display surface or the adjoining areas since this may cause the color tone to vary.

11.1.4. The polarizer covering the display surface of the LCD module is soft and easily scratched. Handle this polarizer carefully.

11.1.5. If the display surface is contaminated, breathe on the surface and gently wipe it with a soft dry cloth. If still not completely clear, moisten cloth with one of the following solvents:

- Isopropyl alcohol
- Ethyl alcohol

Solvents other than those mentioned above may damage the polarizer. Especially, do not use the following:

- Water
- Ketene

11.1.6. Do not attempt to disassemble the LCD Module.

11.1.7. If the logic circuit power is off, do not apply the input signals.

11.1.8. To prevent destruction of the elements by static electricity, be careful to maintain an optimum work environment.

11.1.8.1. Be sure to ground the body when handling the LCD Modules.

11.1.8.2. Tools required for assembly, such as soldering irons, must be properly ground.

11.1.8.3. To reduce the amount of static electricity generated, do not conduct assembly and other work under dry conditions.

11.1.8.4. The LCD Module is coated with a film to protect the display surface. Be care when peeling off this protective film since static electricity may be generated.

11.2 Storage Precautions

11.2.1. When storing the LCD modules, avoid exposure to direct sunlight or to the light of fluorescent lamps.

11.2.2. The LCD modules should be stored under the storage temperature range. If the LCD modules will be stored for a long time, the recommend condition is:

Temperature : 0℃ ~ 40℃ Relatively humidity: ≤80%

11.2.3. The LCD modules should be stored in the room without acid, alkali and harmful gas.



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11.3 Transportation Precautions

The LCD modules should be no falling and violent shocking during transportation, and also should avoid excessive press, water, damp and sunshine.